IIDWay Technology Co. Ltd

PRODUCT SPECIFICATIONS

For Customer: _____ ☐ : APPROVAL FOR SPECIFICATION

Customer Model No. _____ ☐ : APPROVAL FOR SAMPLE

Module No.: *GZ70114-DIT027TH* *Date : 2023.10.20*

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For Customer's Acceptance:

Approved By	Comment

PREPARED	CHECKED	APPROVER
YZJ		

2. Revision Record

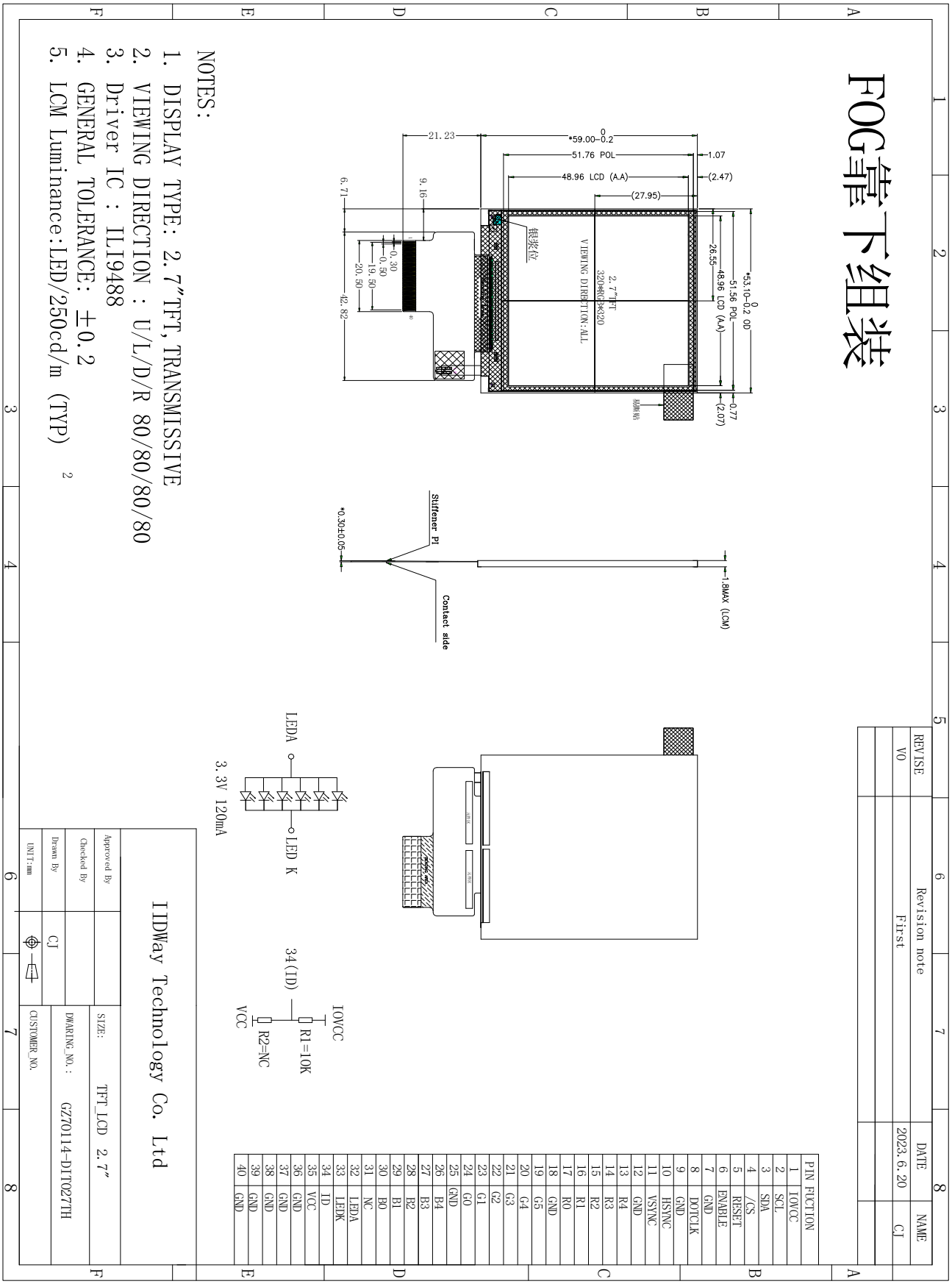
Date	Rev.No.	Page	Revision Items	Prepared
2023.10.20	V0		The first release	YZJ

3. General Specifications

GZ70114-DIT027TH is a TFT-LCD module. It is composed of a TFT-LCD panel, driver IC, FPC,a back light unit. The 2.7″ display area contains 320x320 pixels and can display up to 16.7M colors. This product accords with RoHS environmental criterion.

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	16.7M		
Viewing Direction	12	O'Clock	
Operating temperature	-30~+85	℃	
Storage temperature	-30~+85	℃	
Module size	Refer to outline drawing	mm	
Active Area(W×H)	48.96X48.96	mm	
Number of Dots	*320x320*	dots	
Driver IC	ILI9488	-	
Power Supply Voltage	2.8	V	
Outline Dimensions	Refer to outline drawing	-	
Backlight	6P-LEDs (white)	pcs	
Interface	RGB16bits	-	

4.Outline.Drawing



5. Absolute Maximum Ratings(Ta=25℃)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25℃)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V_{DD}	-0.3	3.3	V	1，2

Notes:

1. *If the module is above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.*
2. *V_{DD} >V_{SS} must be maintained.*
3. *Please be sure users are grounded when handing LCD Module.*

5.2 Environmental Absolute Maximum Ratings.

Item	Storage		Operating	
	MIN.	MAX.	MIN.	MAX.
Ambient Temperature	-30℃	85℃	-30℃	85℃
Humidity	-	-	-	-

1. *The response time will become lower when operated at low temperature.*
2. *Background color changes slightly depending on ambient temperature.*

   The phenomenon is reversible.
3. *Ta<=40 ℃:85%RH MAX.*

   Ta>=40 ℃:Absolute humidity must be lower than the humidity of 85%RH at 40 ℃.

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics(Vss=0V ,Ta=25℃)

Parameter		Symbol	Condition	Min	Typ	Max	Unit	Note
Power supply		VDD	Ta=25℃	2.5	2.8	3.3	V	
Input voltage	'H'	V_{IH}	V_{DD}=3.3V	0.7V_{DD}	-	V_{DD}	V	
	'L'	V_{IL}	V_{DD}=3.3V	0	-	0.3V_{DD}	V	

Note: If one of the above items is exceeded its maximum limitation momentarily, the quality of the product may be degraded. Absolute maximum limitation, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the recommend range.

6.2 LED backlight specification(VSS=0V ,Ta=25℃)

Item	Symbol	Condition	Min	Typ	Max	Unit	Note
Supply voltage VLED	V_f	If=120mA	-	3.3	-	V	
Uniformity	∆Bp	If=120mA	75	-	-	%	
LED Life Time	-	-	20000	-	-	hr	1

Note 1: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25℃

6.3 Interface signals

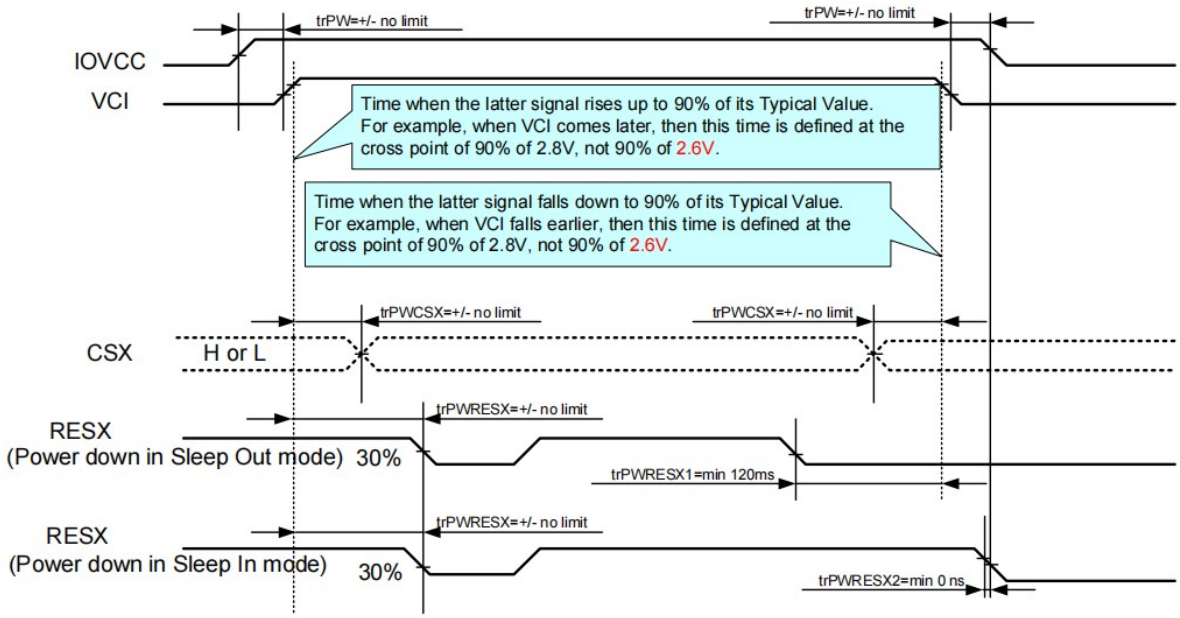
6.3.1 LCM PIN

Pin No.	Symbol	I/O	Function
1	IOVCC	P	I/O circuit or logic supply voltage
2	SCL	I	Serial interface clock pin
3	SDA	I	Serial in/out signal pin
4	CS	I	Chip select input pin
5	RESET	I	Global reset signal input pin
6	ENABLE	I	Output pin for PWM (Pulse Width Modulation) signal of LED driving.
7	GND	P	Ground
8	DOTCLK	I	Dot clock signal
9	GND	P	Ground
10	HSYNC	I	Line synchronizing signal
11	VSYNC	I	Vertical synchronizing signal
12	GND	P	Ground
13-17	R4-R0	I	Red data bus
18	GND	P	Ground
19-24	G5-G0	I	Green data bus
25	GND	P	Ground
26-30	B4-B0	I	Blue data bus
31	NC		No connection
32	LEDA	P	LED back light(Anode)
33	LEDK	P	LED back light(Cathode)
34	ID	I	ID select pin
35	VCC	P	Power supply
36-40	GND	P	Ground

6.4 Power Sequence

6.4.1 Case 1 – RESX Line is Held High or Unstable by Host at Power ON

If the RESX line is held High or unstable by the host during Power On, then Hardware Reset must be applied after both VCI and IOVCC have been applied. Otherwise, the correct functionality is not guaranteed. There is no timing restriction upon this hardware reset.



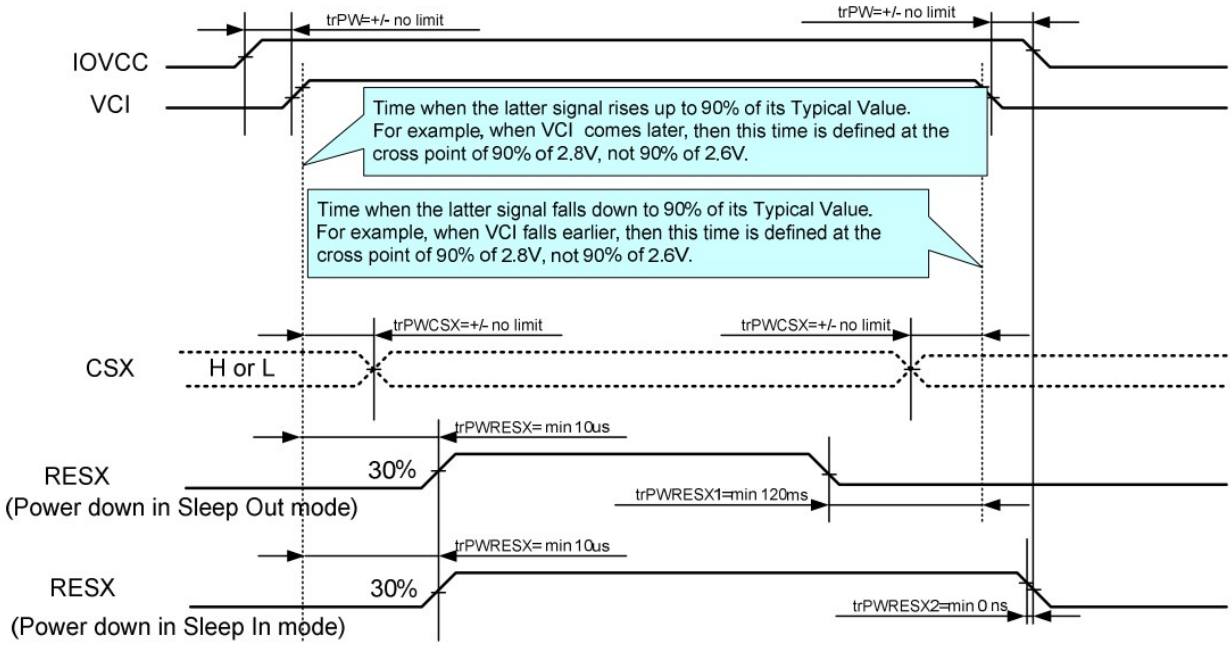
trPWRESX1 is applied to RESX falling in the Sleep Out Mode

trPWRESX2 is applied to RESX falling in the Sleep In Mode

Note: Unless otherwise specified, timings herein show the cross point at 50% of the signal power level.

6.4.2 Case 2 – RESX Line is Held Low by Host at Power ON

If the RESX line is held Low (and stable) by the host during Power On, then the RESX must be held low for a minimum of 10µsec after both VCI and IOVCC have been applied.

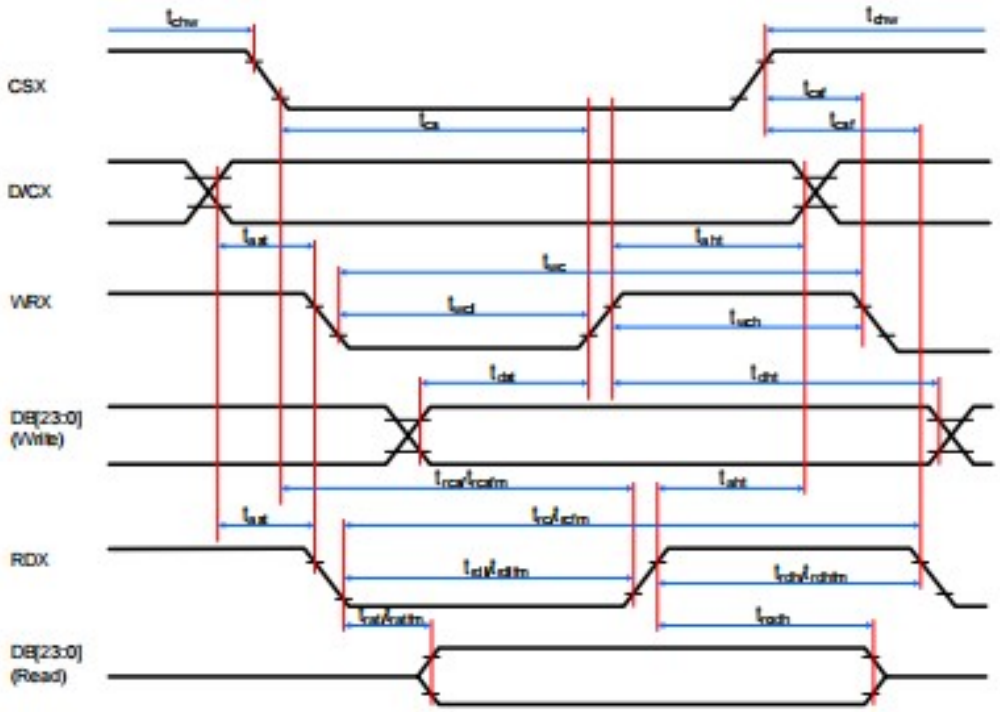


trPWRESX1 is applied to RESX falling in the Sleep Out Mode
trPWRESX2 is applied to RESX falling in the Sleep In Mode

6.5 Timing Characteristics

6.5.1 AC Electrical Characteristics

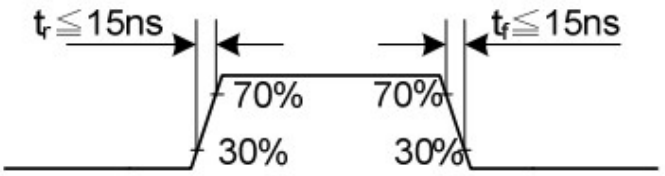
DBI Type B Timing Characteristics



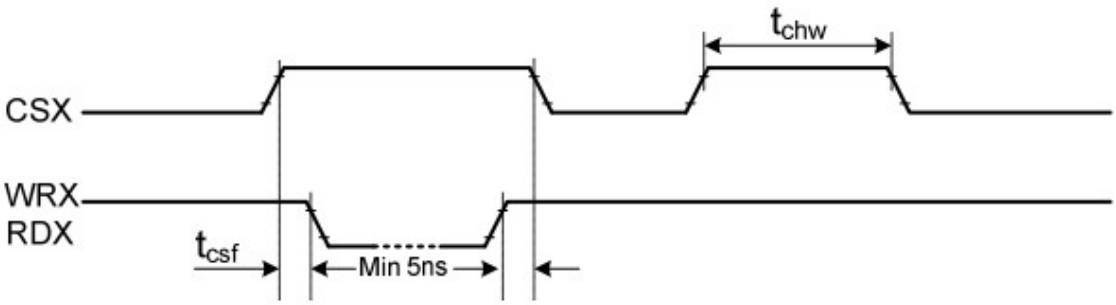
Signal	Symbol	Parameter	min	max	Unit	Description
D/CX	tast	Address setup time	0	-	ns	-
	that	Address hold time (Write/Read)	0	-	ns	-
CSX	tchw	CSX "H" pulse width	0	-	ns	-
	tcs	Chip Select setup time (Write)	15	-	ns	-
	trcs	Chip Select setup time (Read ID)	45	-	ns	-
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	-
	tcsf	Chip Select Wait time (Write/Read)	0	-	ns	-
WRX	twc	Write cycle	40	-	ns	-
	twrh	Write Control pulse H duration	15	-	ns	-
	twrl	Write Control pulse L duration	15	-	ns	-
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	When read from Frame Memory
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	When read ID data
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
DB [23:0], DB [17:0], DB [15:0], DB [8:0], DB [7:0]	tdst	Write data setup time	10	-	ns	For maximum, CL=30pF For minimum, CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Notes:

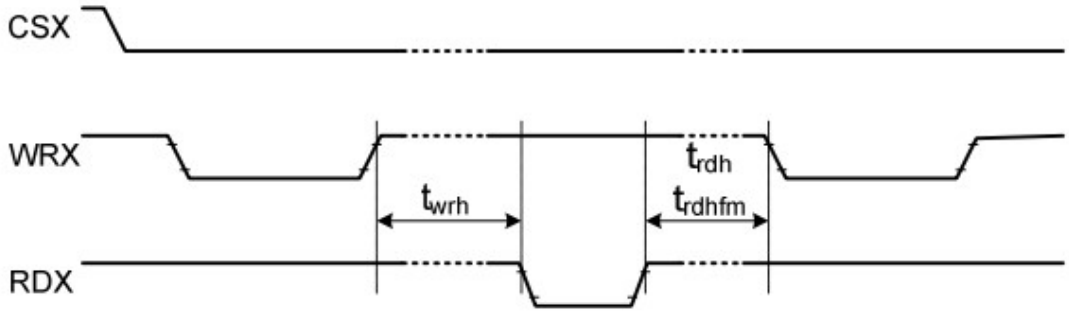
1. Ta = -30 to 70 ℃, IOVCC = 1.65V to 3.3V, VCI = 2.5V to 3.3V, AGND = DGND = 0V
2. Logic high and low levels are specified as 30% and 70% of IOVCC for input signals.
3. Input signal rising time and falling time:

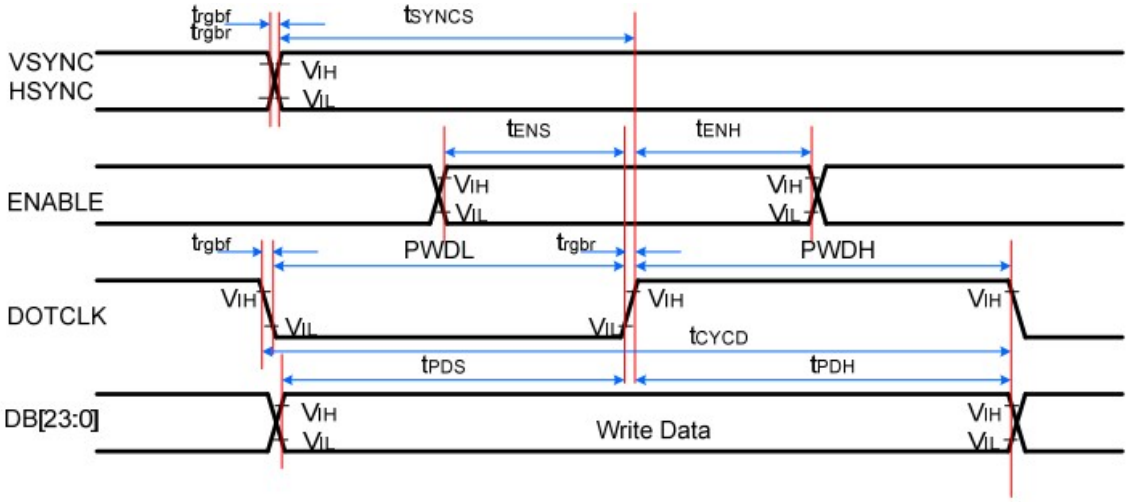


4. The CSX timing:



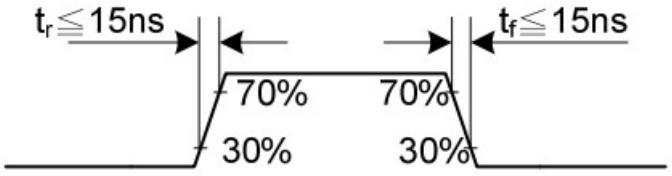
5. The Write to Read or the Read to Write timing:





Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC/ HSYNC	t_{SYNCS}	VSYNC/HSYNC setup time	15	-	ns	
	t_{SYNCH}	VSYNC/HSYNC hold time	15	-	ns	
ENABLE	t_{ENS}	ENABLE setup time	15	-	ns	
	t_{ENH}	ENABLE hold time	15	-	ns	
DB [23:0]	t_{POS}	Data setup time	15	-	ns	16-/18-/24-bit bus RGB interface mode
	t_{PDH}	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	20	-	ns	
	PWDL	DOTCLK low-level period	20	-	ns	
	t_{CYCD}	DOTCLK cycle time	50	-	ns	
	t_{rgbr} , t_{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 ℃, IOVCC = 1.65V to 3.3V, VCI = 2.5V to 3.3V, AGND = DGND = 0V



7. *Optical Characteristics*

Item	Symbol		**Condition**	Min.	Typ.	Max.	Unit	Note
Brightness	Bp		θ=0° Φ=0°	-	250	-	Cd/m^2	1
Uniformity	⊿Bp			80	-	-	%	1,2
Viewing Angle	3:00		Cr≥10	-	80	-	Deg	3
	6:00			-	80	-		
	9:00			-	80	-		
	12:00			-	80	-		
Contrast Ratio	Cr		θ=0° Φ=0°	1000	1200	-	-	4
Response Time	$T_{r+}T_f$			-	30	35	ms	5
Color of CIE Coordinate	W	x	θ=0° Φ=0°	Typ-0.05	TBD	Typ+0.05	-	1,6
		y					-	
	R	x					-	
		y					-	
	G	x					-	
		y					-	
	B	x					-	
		y					-	
NTSC Ratio	S			65	70	-	%	

Note：The parameter is slightly changed by temperature, driving voltage and materiel

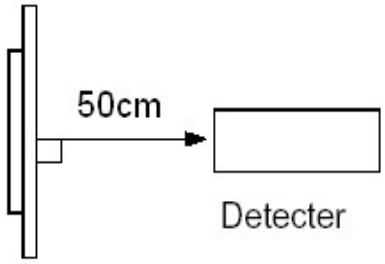
*Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipm*ent BM-7 (Φ5mm)

Measuring condition:

- *Measuring surroundings: Dark room.*
- *Measuring temperature: Ta=25℃.*
- *Adjust operating voltage to get optimum contrast at the center of the display.*

Measured value at the center point of LCD panel after more than 5 minutes while backlight

turning on.

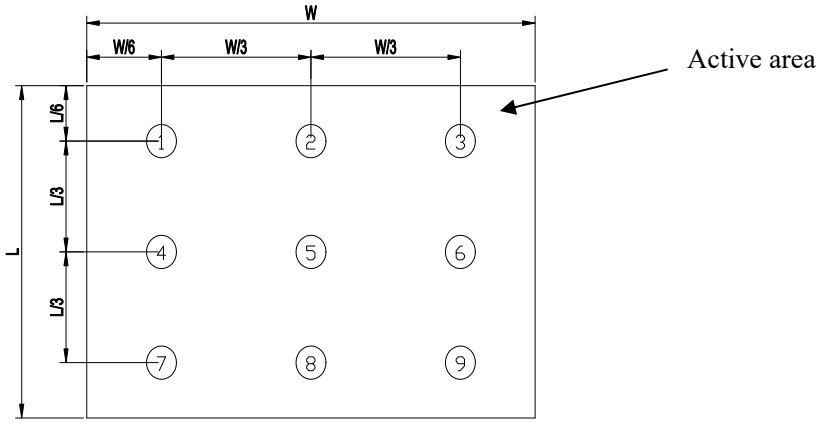


Note 2: The luminance uniformity is calculated by using following formula.

⊿Bp = Bp (Min.) / Bp (Max.)×100 (%)

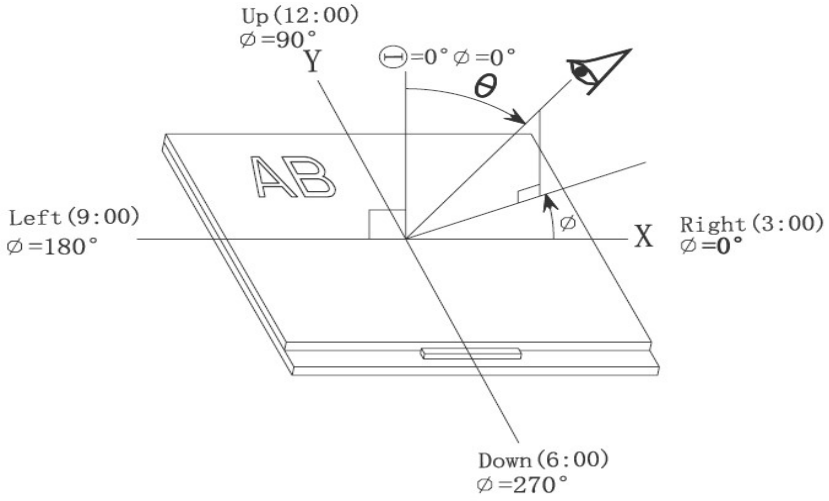
Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.

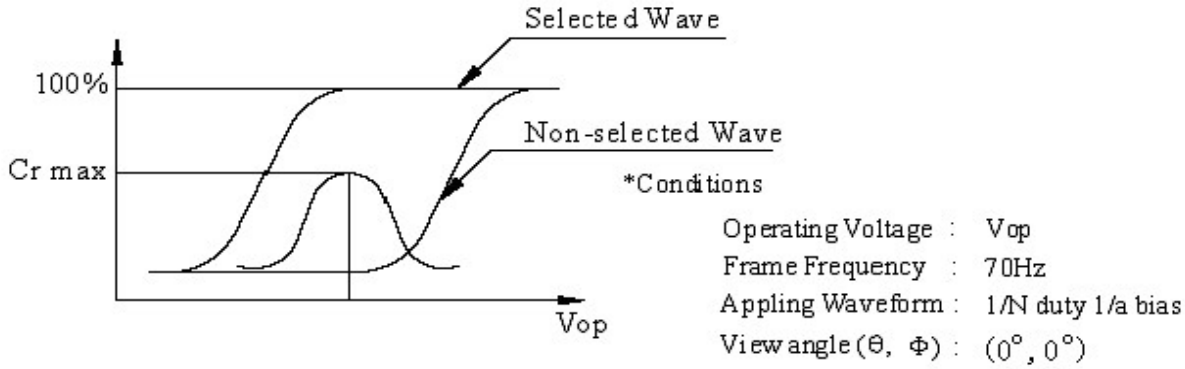


Note 3: The definition of viewing angle:

Refer to the graph below marked by ϑ and Φ



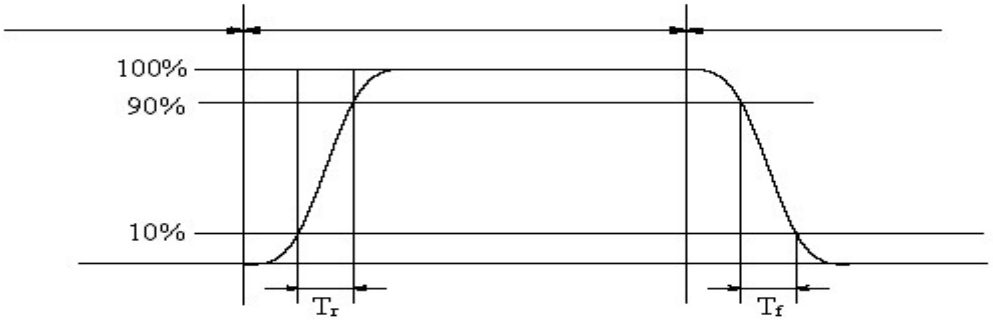
Note 4: Definition of contrast ratio.(Test LCD using DMS501)



$$Contrast\ ratio(Cr) = \frac{Brightness\ of\ selected\ dots}{Brightness\ of\ non-selected\ dots}$$

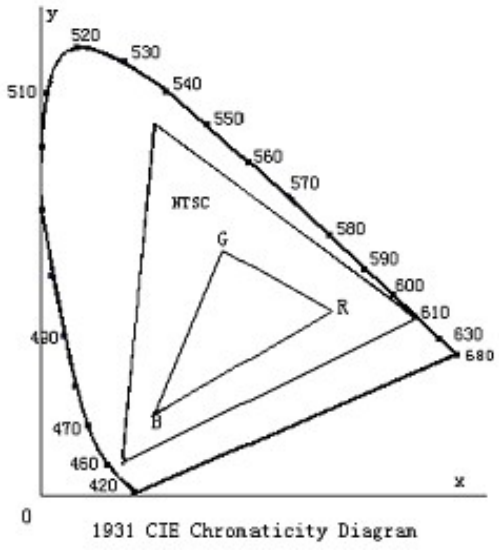
Note 5: Definition of Response time. (Test LCD using DMS501):

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes.Refer to figure as below.



The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.

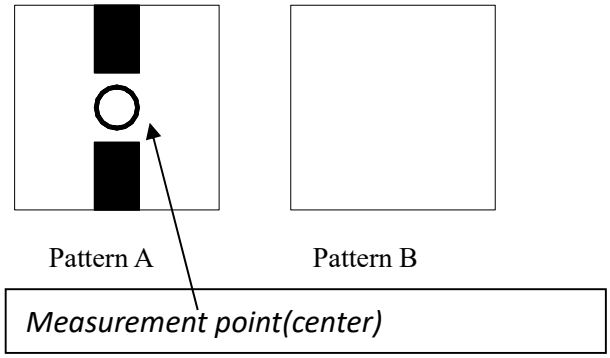


Color gamut:

$$\mathbf{S = \frac{area\ of\ RGB\ triangle}{area\ of\ NTSC\ triangle} \times 100\%}$$

Note 7: Definition of cross talk.

*Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness*100*



Electric volume value=3F+/-3Hex

8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
1	High Temperature Storage	85℃±2℃ 96H Restore 2H at 25℃ Power off	1. After testing, cosmetic and electrical defects should not happen. 2. Total current consumption should not be more than twice of initial value.
2	Low Temperature Storage	-30℃±2℃ 96H Restore 2H at 25℃ Power off	
3	High Temperature Operation	85℃±2℃ 96H Restore 2H at 25℃ Power on	
4	Low Temperature Operation	-30℃±2℃ 96H Restore 4H at 25℃ Power on	
5	High Temperature/Humidity Operation	60℃±2℃ 90%RH 96H Power on	
6	Temperature Cycle	--30℃←----------→80℃ 30min 5min 30min after 5 cycle, Restore 2H at 25℃ Power off	

Note: Operation: Supply 3.3V for logic system.

The inspection terms after reliability test, as below

ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

9. Precautions for Use of LCD Modules

9.1 Handling Precautions

9.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

— Isopropyl alcohol — Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

— Water — Ketone — Aromatic solvents

9.1.6 Do not attempt to disassemble the LCD Module.

9.1.7 If the logic circuit power is off, do not apply the input signals.

9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

a. Be sure to ground the body when handling the LCD Modules.

b. Tools required for assembly, such as soldering irons, must be properly ground.

c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

9.2 Storage precautions

9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

9.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0℃ ～ 40℃

Relatively humidity: ≤80%

9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

9.3 ***The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.***

END